

NCP4683

300 mA, Low Dropout Regulator

The NCP4683 is a CMOS Linear voltage regulator with 300 mA output current capability. The device has high output voltage accuracy, low supply current and high ripple rejection. The NCP4683 is easy to use, with output current fold-back protection circuit included. A Chip Enable function is included to save power by lowering supply current. The line and load transient responses are very good, thus this regulator is suitable for use as a power supply for communication equipment.

Features

- Operating Input Voltage Range: 1.40 V to 5.25 V
- Output Voltage Range: 0.8 V to 3.6 V (available in 0.1 V steps)
- Output Voltage Accuracy: $\pm 1.0\%$ ($V_{OUT} > 2.0$ V)
- Supply Current: 50 μ A
- Dropout Voltage: 0.25 V ($I_{OUT} = 300$ mA, $V_{OUT} = 2.8$ V)
- High PSRR: 70 dB ($f = 1$ kHz)
- Line Regulation: 0.02%/V Typ.
- Stable with Ceramic Capacitors: 1.0 μ F or more
- Current Fold Back Protection
- Available in UDFN4 1.0 x 1.0 mm, SC-70, SOT23 Packages
- These are Pb-Free Devices

Typical Applications

- Battery-powered Equipment
- Networking and Communication Equipment
- Cameras, DVRs, STB and Camcorders
- Home Appliances

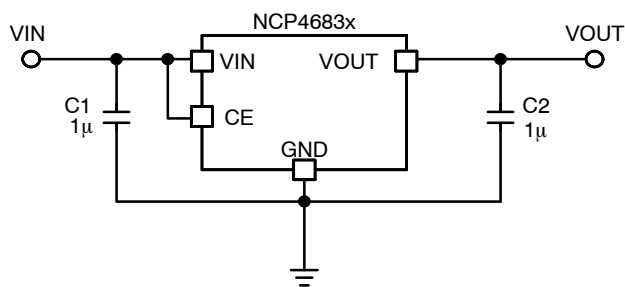


Figure 1. Typical Application Schematic



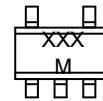
ON Semiconductor®

<http://onsemi.com>

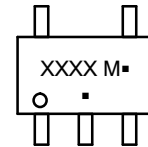
MARKING DIAGRAMS



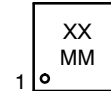
SOT-23-5
CASE 1212



SC-70
CASE 419A



UDFN4
CASE 517BR



XX, XXX, XXXX = Specific Device Code
M, MM = Date Code
A = Assembly Location
Y = Year
W = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 18 of this data sheet.

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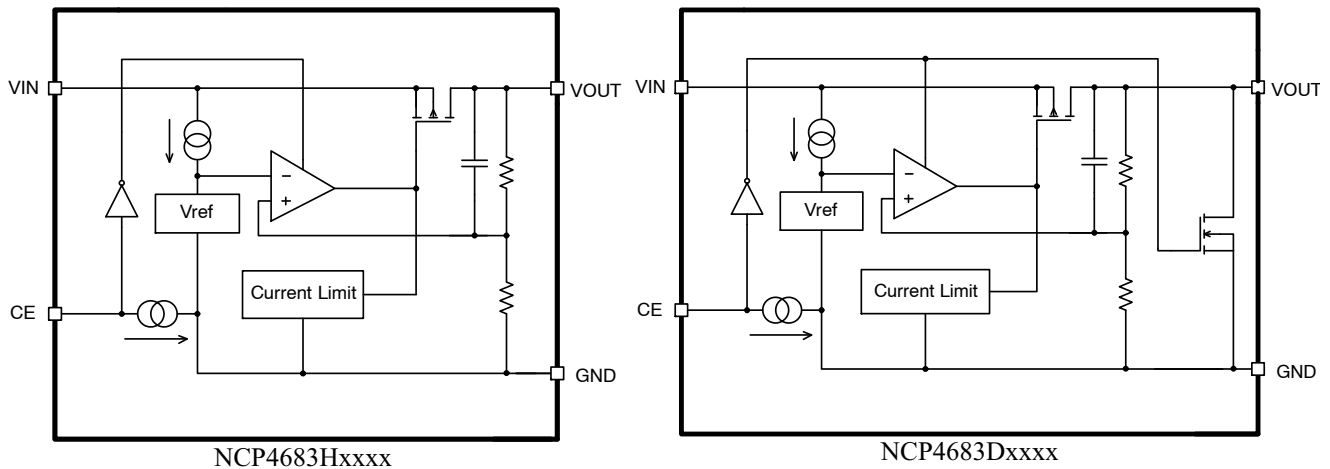


Figure 2. Simplified Schematic Block Diagram

PIN FUNCTION DESCRIPTION

Pin No. UDFN1010*	Pin No. SC-70	Pin No. SOT23	Pin Name	Description
1	4	5	V _{OUT}	Output pin
2	3	2	GND	Ground
3	1	3	CE	Chip enable pin (Active "H")
4	5	1	V _{IN}	Input pin
-	2	4	NC	No connection

*Tab is GND level. (They are connected to the reverse side of this IC.
The tab is better to be connected to the GND, but leaving it open is also acceptable.

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	V _{IN}	6.0	V
Output Voltage	V _{OUT}	-0.3 to V _{IN} + 0.3	V
Chip Enable Input	V _{CE}	-0.3 to 6.0	V
Output Current	I _{OUT}	400	mA
Power Dissipation UDFN1010	P _D	400	mW
Power Dissipation SC-70		380	
Power Dissipation SOT23		420	
Junction Temperature	T _J	-40 to 150	°C
Storage Temperature	T _{STG}	-55 to 125	°C
ESD Capability, Human Body Model (Note 2)	ESD _{HBM}	2000	V
ESD Capability, Machine Model (Note 2)	ESD _{MM}	200	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.
2. This device series incorporates ESD protection and is tested by the following methods:
ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114)
ESD Machine Model tested per AEC-Q100-003 (EIA/JESD22-A115)
Latchup Current Maximum Rating tested per JEDEC standard: JESD78.

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THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Characteristics, UDFN 1.0 x 1.0 mm Thermal Resistance, Junction-to-Air	$R_{\theta JA}$	250	$^{\circ}\text{C}/\text{W}$
Thermal Characteristics, SOT23 Thermal Resistance, Junction-to-Air	$R_{\theta JA}$	238	$^{\circ}\text{C}/\text{W}$
Thermal Characteristics, SC-70 Thermal Resistance, Junction-to-Air	$R_{\theta JA}$	263	$^{\circ}\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS

$-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$; $V_{IN} = V_{OUT(NOM)} + 1\text{ V}$ or 2.5 V , whichever is greater; $I_{OUT} = 1\text{ mA}$, $C_{IN} = C_{OUT} = 1.0\text{ }\mu\text{F}$, unless otherwise noted.
Typical values are at $T_A = +25^{\circ}\text{C}$.

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit	
Operating Input Voltage		V_{IN}	1.40		5.25	V	
Output Voltage	$T_A = +25^{\circ}\text{C}$	V_{OUT}	$V_{OUT} \geq 2.0\text{ V}$	x0.99	x1.01	V	
			$V_{OUT} < 2.0\text{ V}$	-20	20	mV	
	$-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$		$V_{OUT} \geq 2.0\text{ V}$	x0.97	x1.03	V	
			$V_{OUT} < 2.0\text{ V}$	-60	60	mV	
Output Voltage Temp. Coefficient	$-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$	$\Delta V_{OUT}/\Delta T_A$		± 80		ppm/ $^{\circ}\text{C}$	
Line Regulation	$V_{OUT(NOM)} + 0.5\text{ V} \leq V_{IN} \leq 5.0\text{ V}$	Line_{Reg}		0.02	0.10	%/V	
Load Regulation	$I_{OUT} = 1\text{ mA}$ to 300 mA	Load_{Reg}		15	40	mV	
Dropout Voltage	$I_{OUT} = 300\text{ mA}$	V_{DO}	$V_{OUT} = 0.8\text{ V}$		0.56	0.72	V
			$V_{OUT} = 0.9\text{ V}$		0.51	0.65	
			$1.0\text{ V} \leq V_{OUT} < 1.2\text{ V}$		0.46	0.59	
			$1.2\text{ V} \leq V_{OUT} < 1.4\text{ V}$		0.39	0.50	
			$1.4\text{ V} \leq V_{OUT} < 1.7\text{ V}$		0.35	0.44	
			$1.7\text{ V} \leq V_{OUT} < 2.1\text{ V}$		0.30	0.39	
			$2.1\text{ V} \leq V_{OUT} < 2.5\text{ V}$		0.26	0.34	
			$2.5\text{ V} \leq V_{OUT} < 3.0\text{ V}$		0.25	0.30	
			$3.0\text{ V} \leq V_{OUT} < 3.6\text{ V}$		0.22	0.29	
Output Current		I_{OUT}	300			mA	
Short Current Limit	$V_{OUT} = 0\text{ V}$	I_{SC}		60		mA	
Quiescent Current		I_Q		50	75	μA	
Standby Current	$V_{CE} = 0\text{ V}$, $T_A = 25^{\circ}\text{C}$	I_{STB}		0.1	1.0	μA	
CE Pin Threshold Voltage	CE Input Voltage "H"	V_{CEH}	1.0			V	
	CE Input Voltage "L"	V_{CEL}			0.4		
CE Pull Down Current		I_{CEPD}		0.3		μA	
Power Supply Rejection Ratio	$V_{IN} = V_{OUT} + 1\text{ V}$ or $V_{IN} = 3\text{ V}$, $\Delta V_{IN} = 0.2\text{ V}_{pk-pk}$, $I_{OUT} = 30\text{ mA}$, $f = 1\text{ kHz}$	PSRR		65		dB	
Output Noise Voltage	$f = 10\text{ Hz}$ to 100 kHz , $I_{OUT} = 30\text{ mA}$, $V_{OUT} = 1.2\text{ V}$, $V_{IN} = 3.2\text{ V}$	V_N		65		μV_{rms}	
Low Output Nch Tr. On Resistance	$V_{IN} = 4\text{ V}$, $V_{CE} = 0\text{ V}$, D version only	R_{LOW}		50		Ω	

TYPICAL CHARACTERISTICS

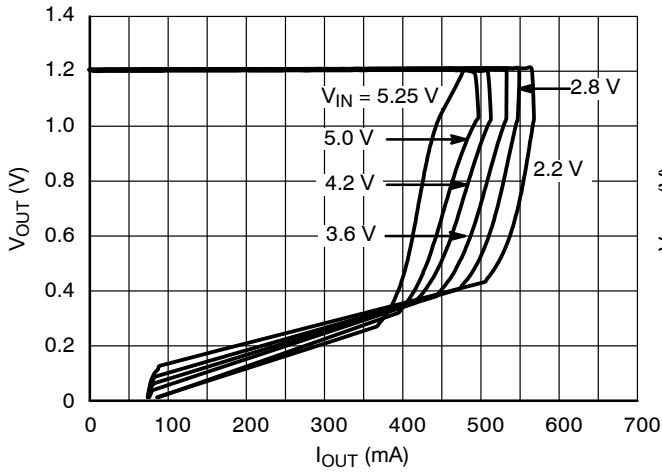


Figure 3. Output Voltage vs. Output Current
1.2 V Version ($T_J = 25^\circ\text{C}$)

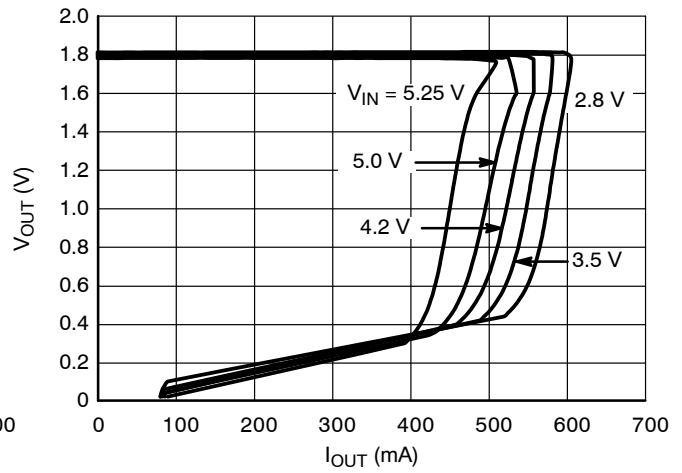


Figure 4. Output Voltage vs. Output Current
1.8 V Version ($T_J = 25^\circ\text{C}$)

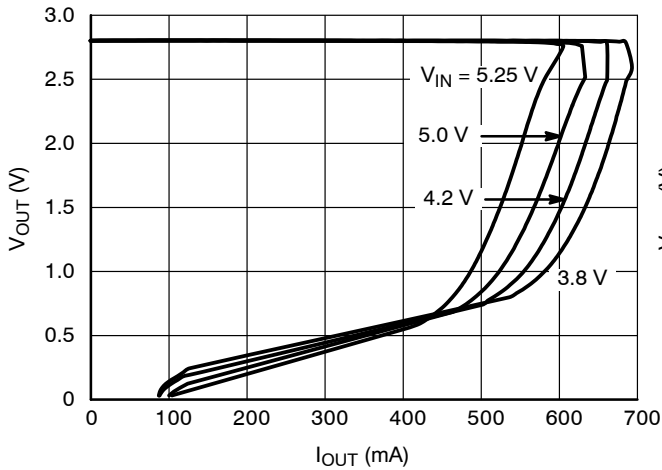


Figure 5. Output Voltage vs. Output Current
2.8 V Version ($T_J = 25^\circ\text{C}$)

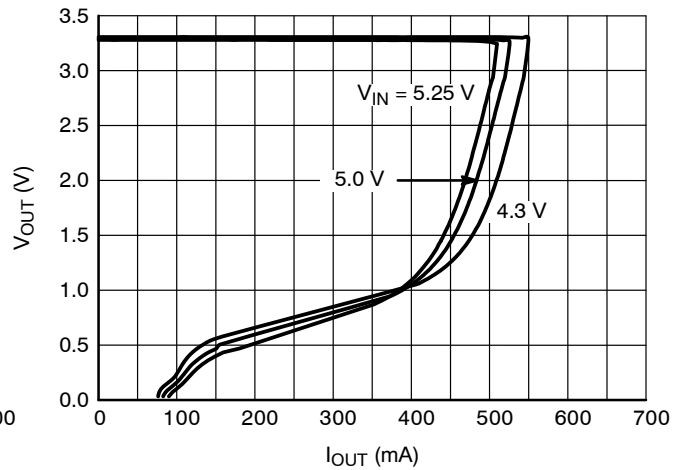


Figure 6. Output Voltage vs. Output Current
3.3 V Version ($T_J = 25^\circ\text{C}$)

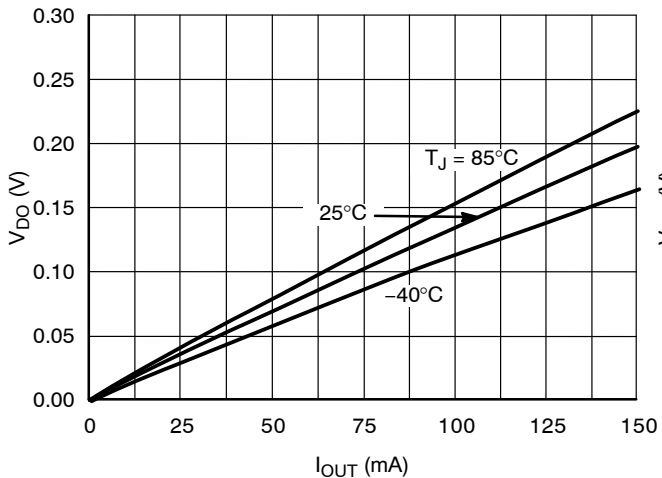


Figure 7. Dropout Voltage vs. Output Current
1.2 V Version

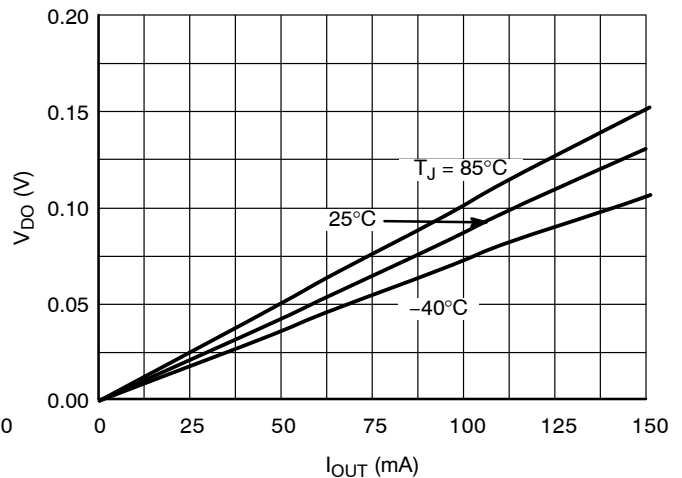


Figure 8. Dropout Voltage vs. Output Current
1.8 V Version

TYPICAL CHARACTERISTICS

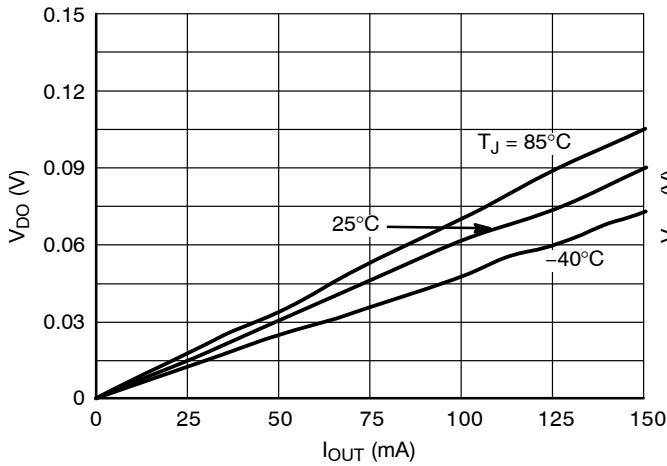


Figure 9. Dropout Voltage vs. Output Current
2.8 V Version

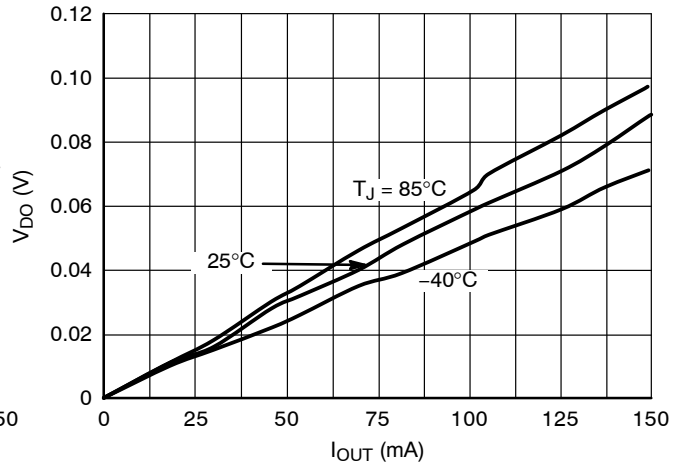


Figure 10. Dropout Voltage vs. Output Current
3.3 V Version

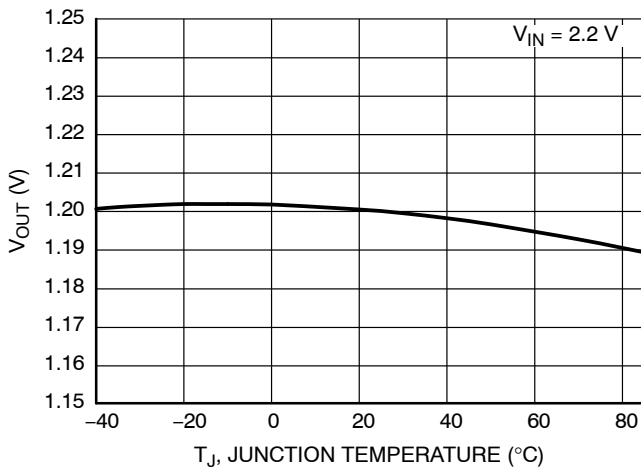


Figure 11. Output Voltage vs. Temperature,
1.2 V Version

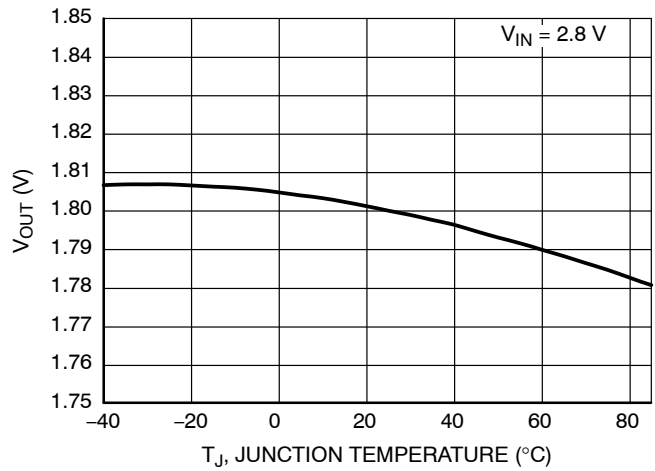


Figure 12. Output Voltage vs. Temperature,
1.8 V Version

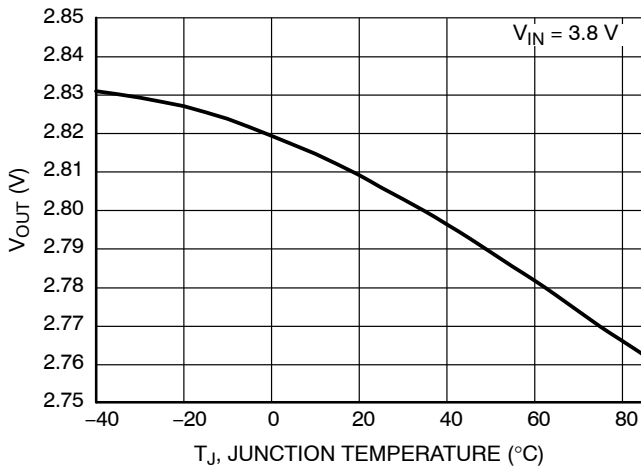


Figure 13. Output Voltage vs. Temperature,
2.8 V Version

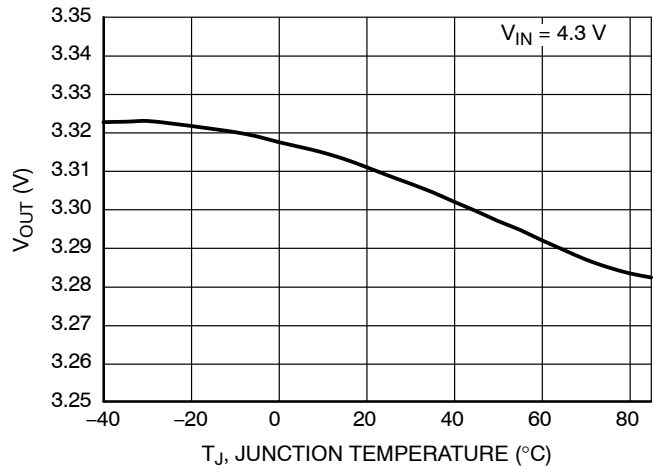


Figure 14. Output Voltage vs. Temperature,
3.3 V Version

TYPICAL CHARACTERISTICS

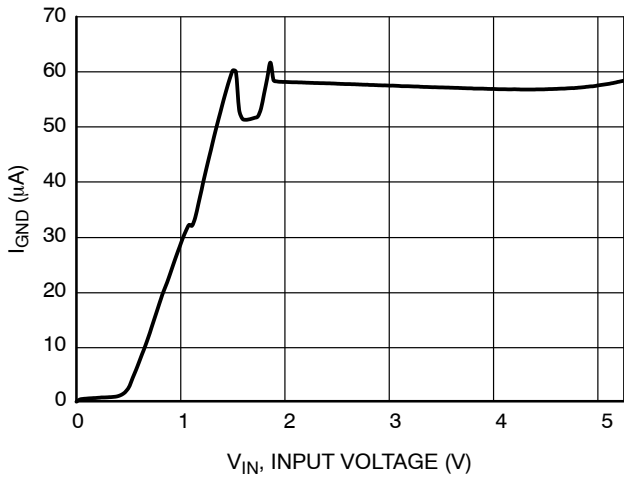


Figure 15. Supply Current vs. Input Voltage, 1.2 V Version

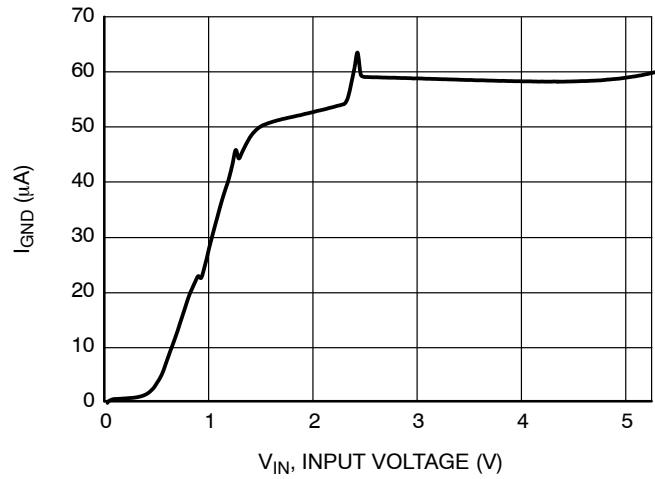


Figure 16. Supply Current vs. Input Voltage, 1.8 V Version

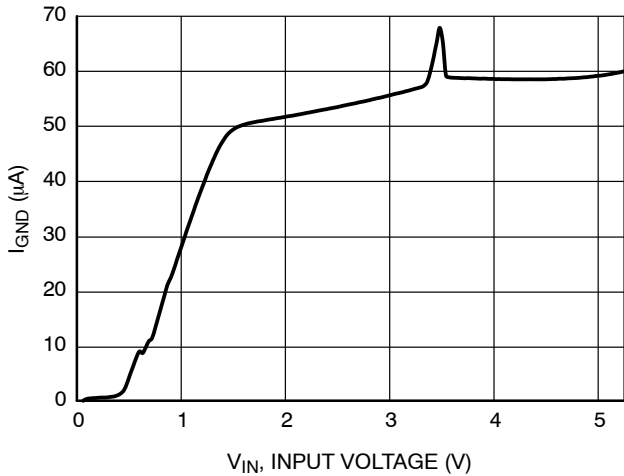


Figure 17. Supply Current vs. Input Voltage, 2.8 V Version

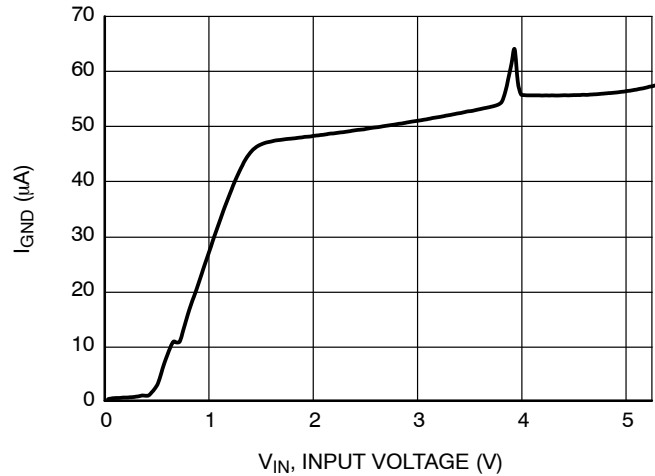


Figure 18. Supply Current vs. Input Voltage, 3.3 V Version

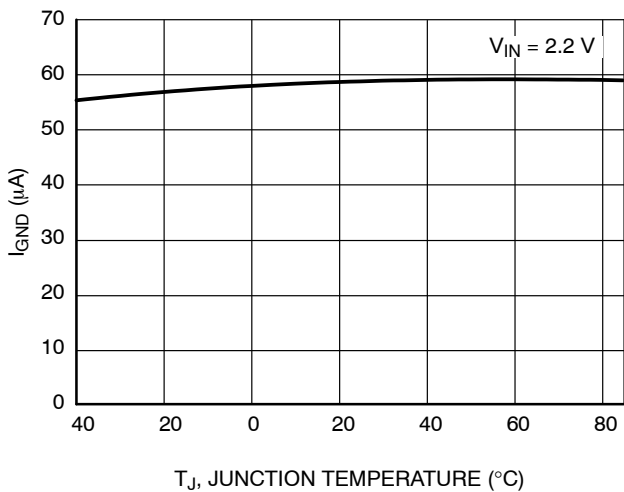


Figure 19. Supply Current vs. Temperature, 1.2 V Version

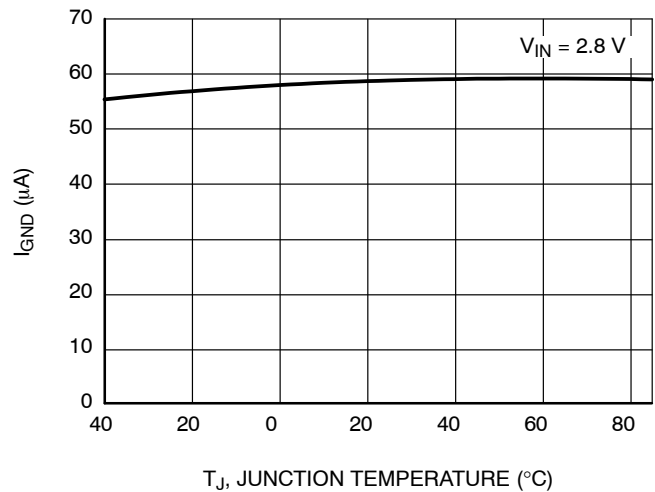


Figure 20. Supply Current vs. Temperature, 1.8 V Version

TYPICAL CHARACTERISTICS

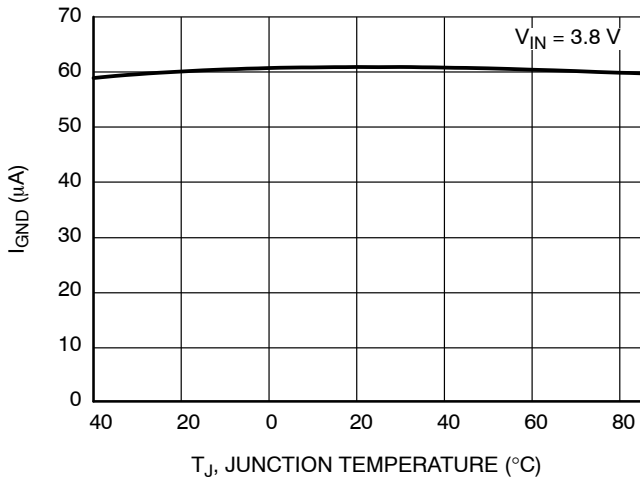


Figure 21. Supply Current vs. Temperature, 2.8 V Version

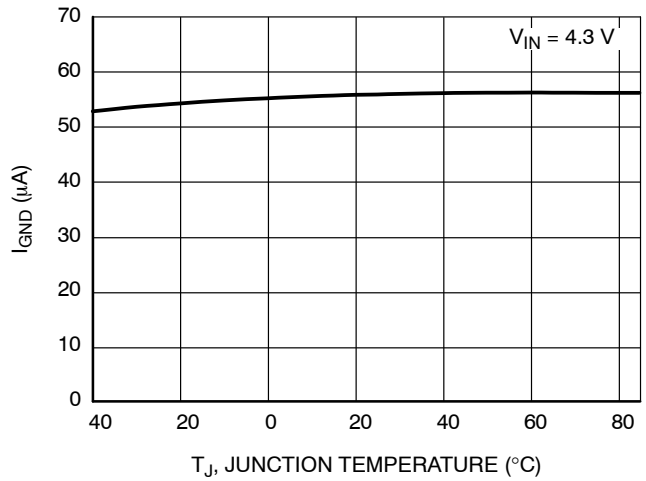


Figure 22. Supply Current vs. Temperature, 3.3 V Version

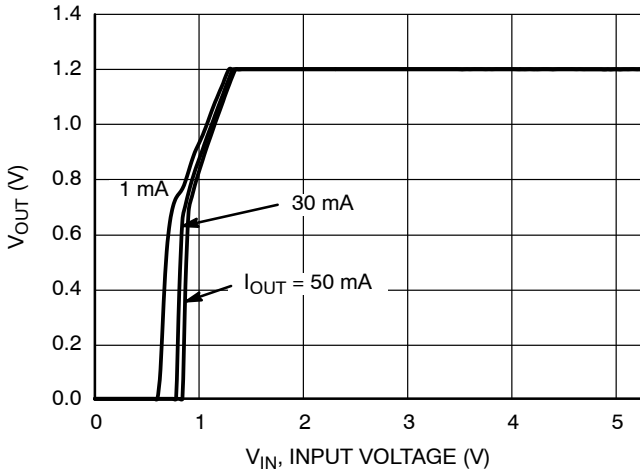


Figure 23. Output Voltage vs. Input Voltage, 1.2 V Version

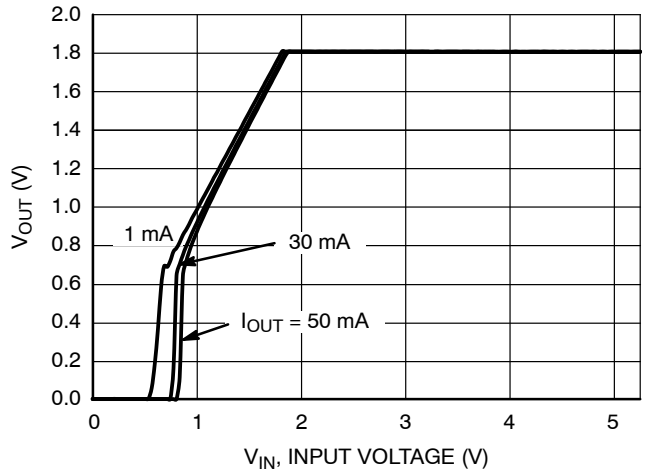


Figure 24. Output Voltage vs. Input Voltage, 1.8 V Version

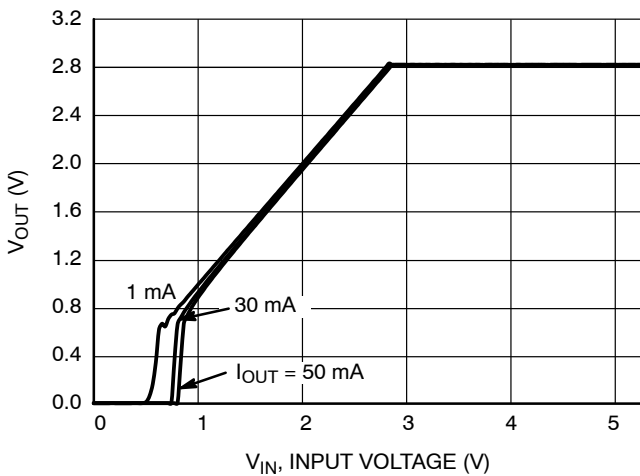


Figure 25. Output Voltage vs. Input Voltage, 2.8 V Version

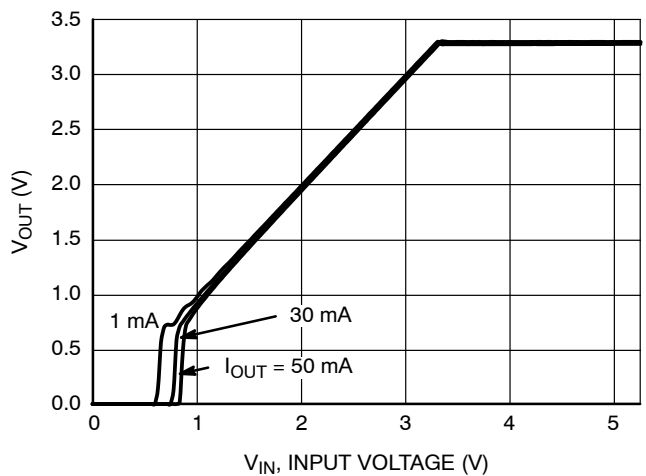


Figure 26. Output Voltage vs. Input Voltage, 3.3 V Version

TYPICAL CHARACTERISTICS

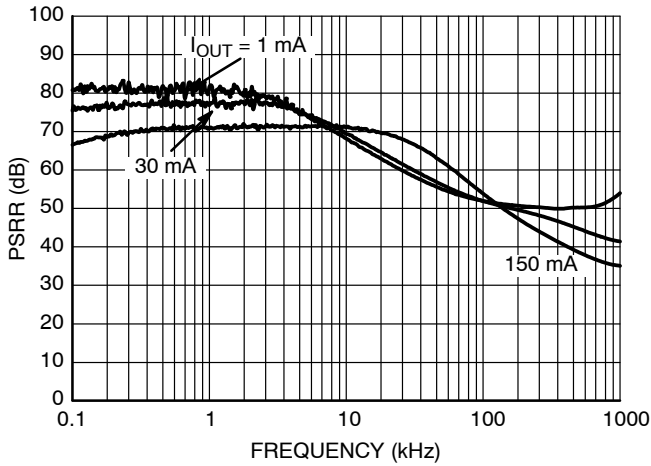


Figure 27. PSRR, 1.2 V Version, $V_{IN} = 3.0$ V

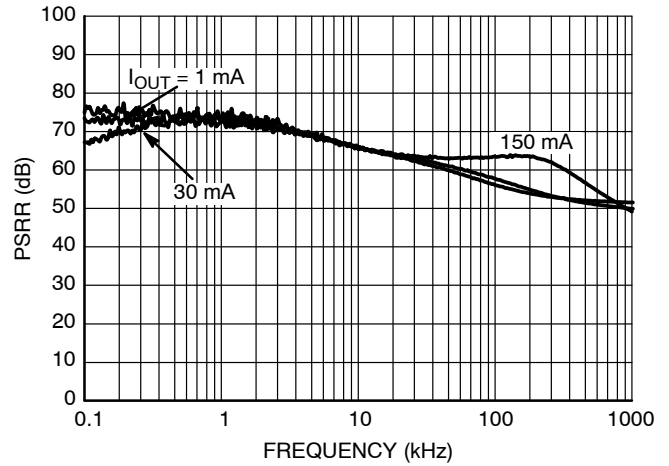


Figure 28. PSRR, 1.8 V Version, $V_{IN} = 3.0$ V

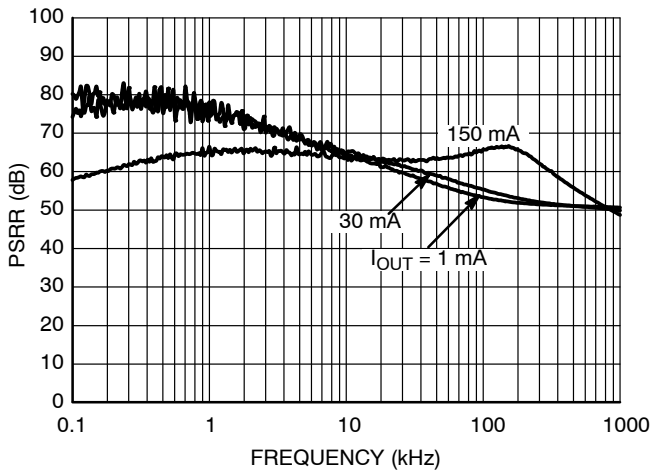


Figure 29. PSRR, 2.8 V Version, $V_{IN} = 3.8$ V

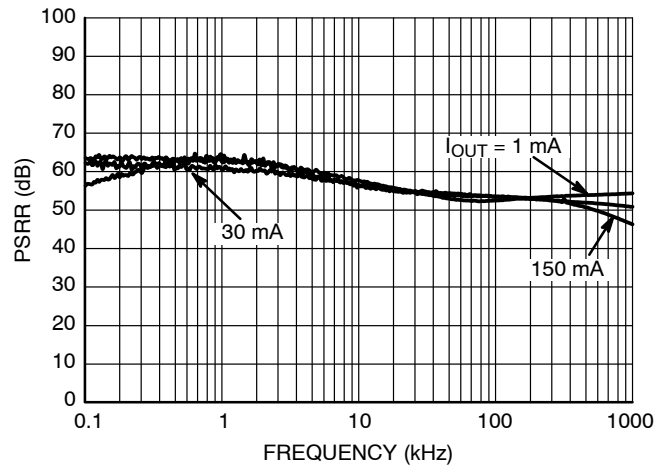


Figure 30. PSRR, 3.3 V Version, $V_{IN} = 4.3$ V

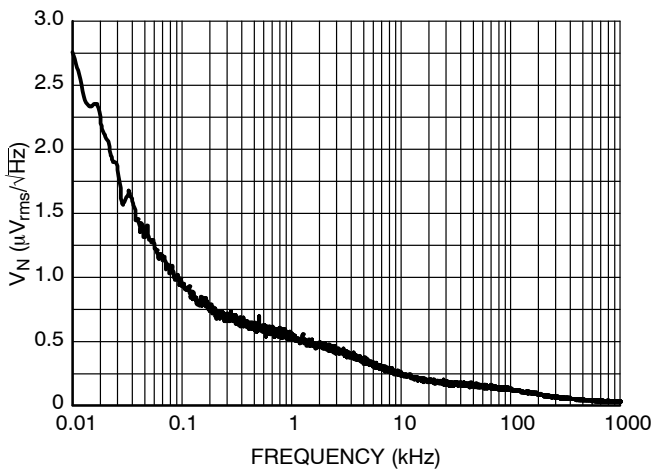


Figure 31. Output Voltage Noise, 1.2 V Version, $V_{IN} = 2.2$ V

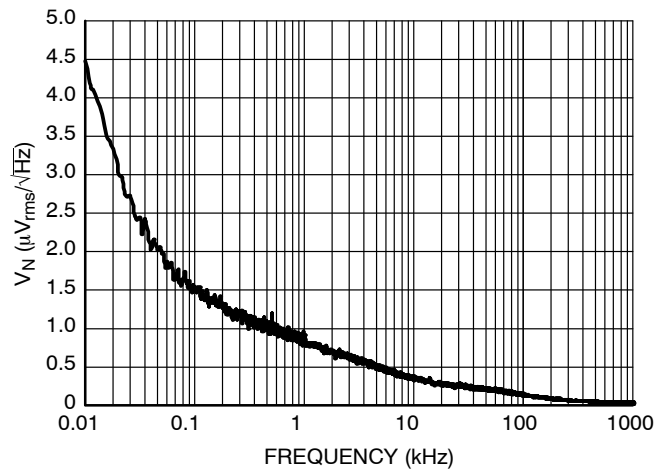
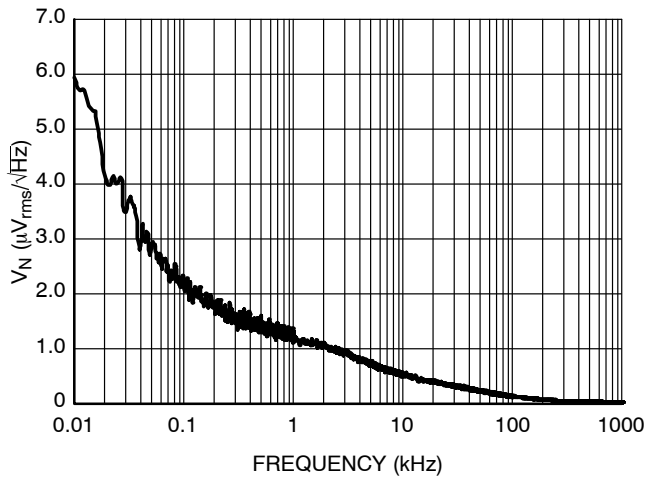


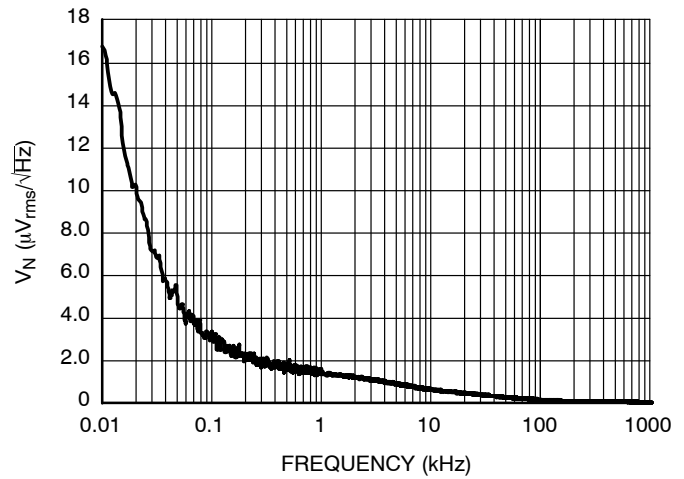
Figure 32. Output Voltage Noise, 1.8 V Version, $V_{IN} = 2.8$ V

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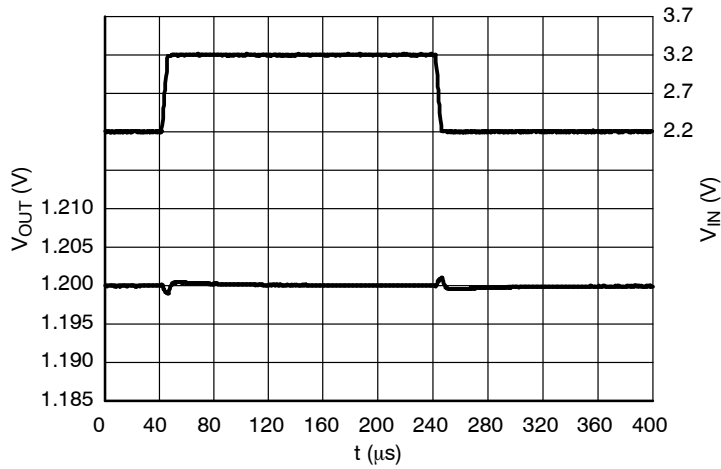
TYPICAL CHARACTERISTICS



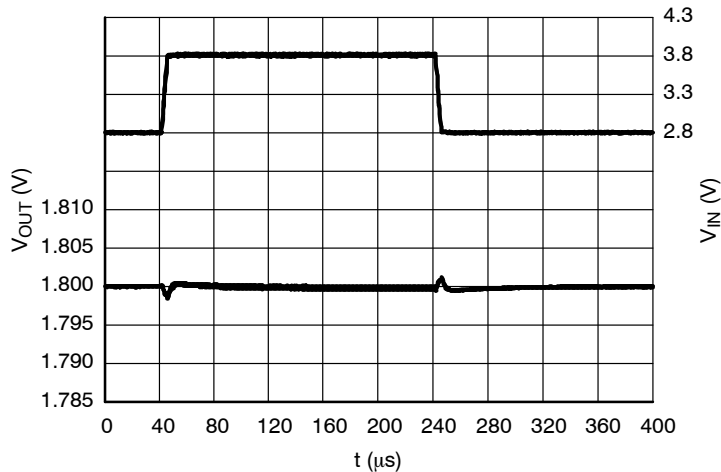
**Figure 33. Output Voltage Noise, 2.8 V Version,
 $V_{IN} = 3.8\text{ V}$**



**Figure 34. Output Voltage Noise, 3.3 V Version,
 $V_{IN} = 4.3\text{ V}$**



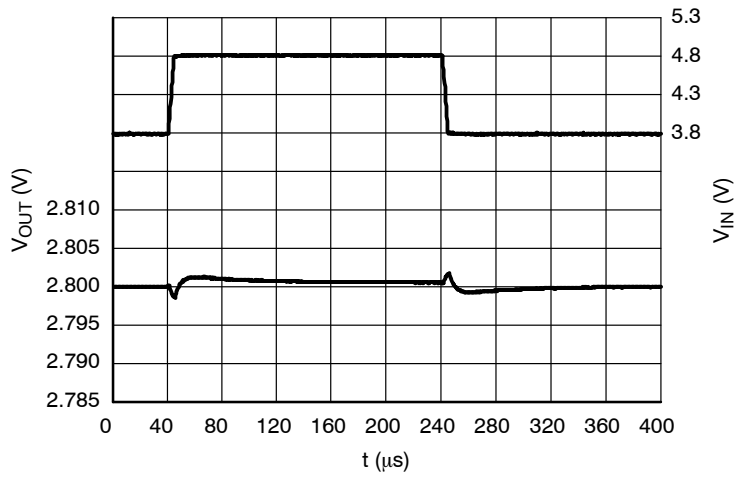
**Figure 35. Line Transients, 1.2 V Version,
 $t_R = t_F = 5\text{ }\mu\text{s}$, $I_{OUT} = 30\text{ mA}$**



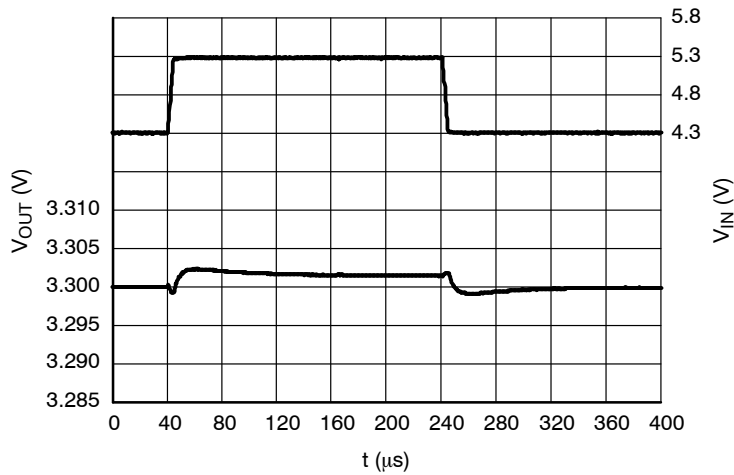
**Figure 36. Line Transients, 1.8 V Version,
 $t_R = t_F = 5\text{ }\mu\text{s}$, $I_{OUT} = 30\text{ mA}$**

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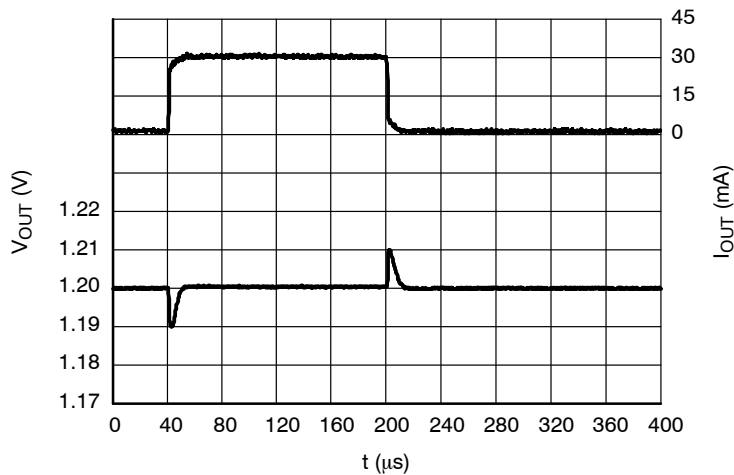
TYPICAL CHARACTERISTICS



**Figure 37. Line Transients, 2.8 V Version,
 $t_{\text{R}} = t_{\text{F}} = 5 \mu\text{s}$, $I_{\text{OUT}} = 30 \text{ mA}$**



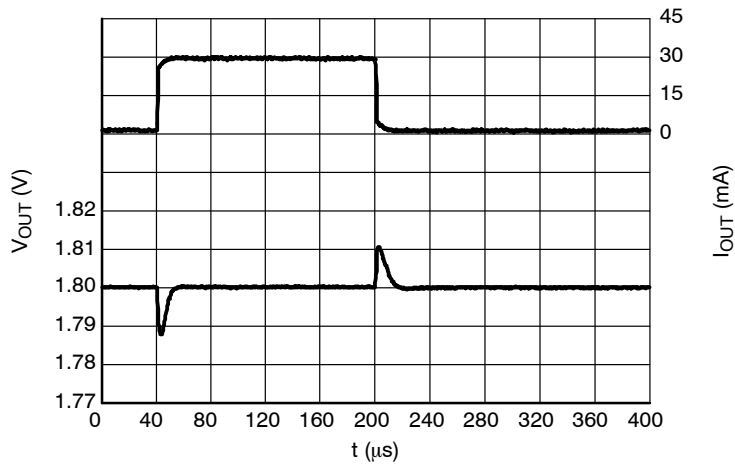
**Figure 38. Line Transients, 3.3 V Version,
 $t_{\text{R}} = t_{\text{F}} = 5 \mu\text{s}$, $I_{\text{OUT}} = 30 \text{ mA}$**



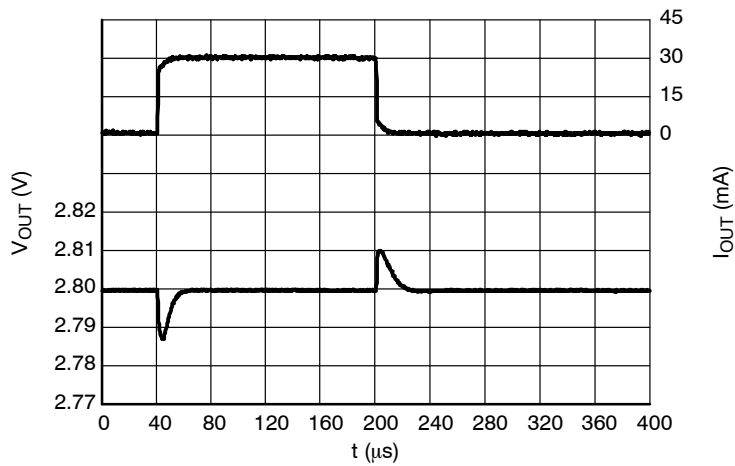
**Figure 39. Load Transients, 1.2 V Version,
 $I_{\text{OUT}} = 1 - 30 \text{ mA}$, $t_{\text{R}} = t_{\text{F}} = 0.5 \mu\text{s}$, $V_{\text{IN}} = 1.8 \text{ V}$**

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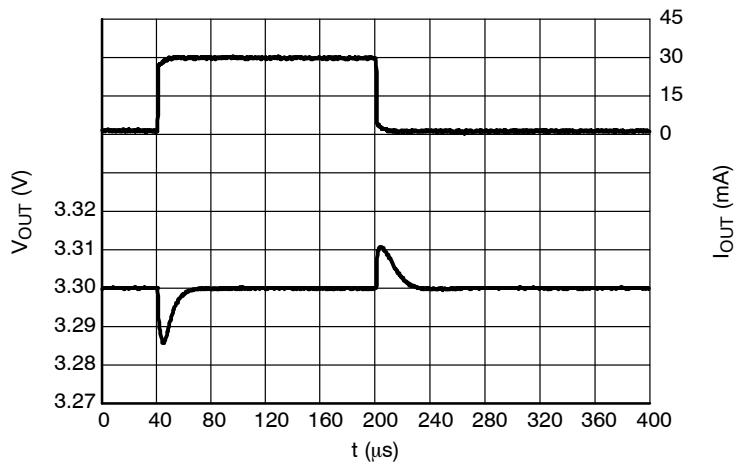
TYPICAL CHARACTERISTICS



**Figure 40. Load Transients, 1.8 V Version,
 $I_{OUT} = 1 - 30$ mA, $t_R = t_F = 0.5$ μ s, $V_{IN} = 2.8$ V**



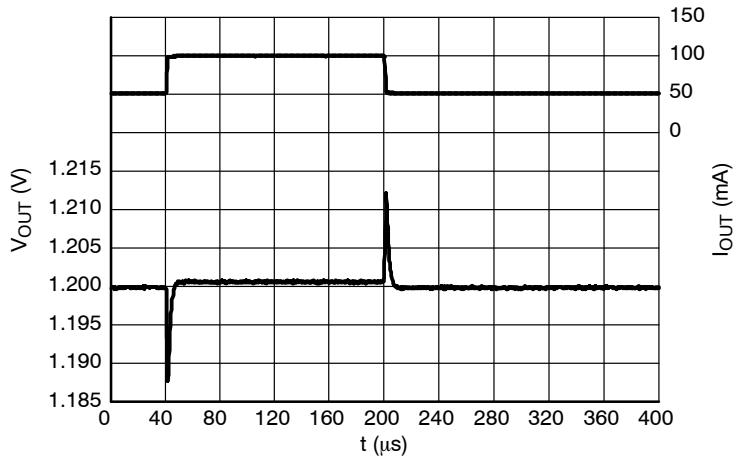
**Figure 41. Load Transients, 2.8 V Version,
 $I_{OUT} = 1 - 30$ mA, $t_R = t_F = 0.5$ μ s, $V_{IN} = 3.8$ V**



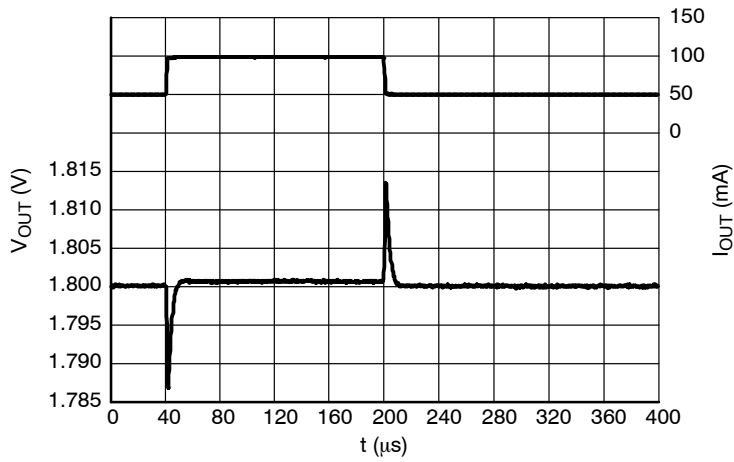
**Figure 42. Load Transients, 3.3 V Version,
 $I_{OUT} = 1 - 30$ mA, $t_R = t_F = 0.5$ μ s, $V_{IN} = 4.3$ V**

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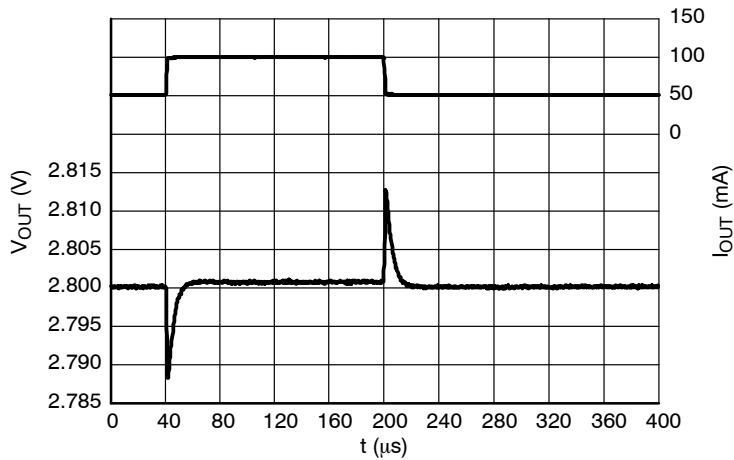
TYPICAL CHARACTERISTICS



**Figure 43. Load Transients, 1.2 V Version,
 $I_{OUT} = 50 - 100$ mA, $t_R = t_F = 0.5 \mu$ s, $V_{IN} = 1.8$ V**



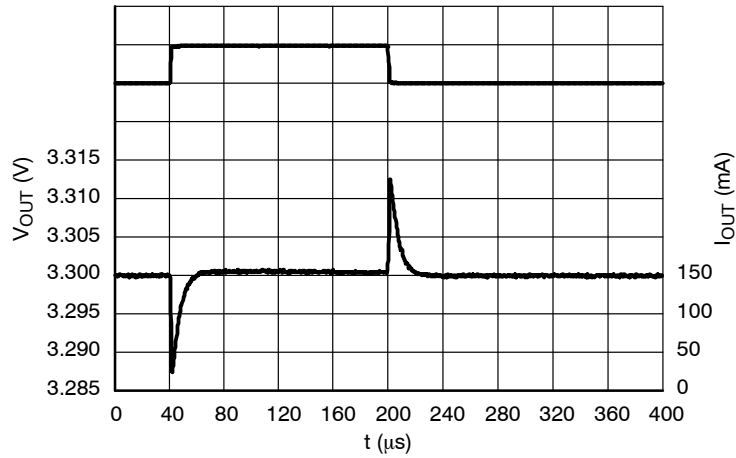
**Figure 44. Load Transients, 1.8 V Version,
 $I_{OUT} = 50 - 100$ mA, $t_R = t_F = 0.5 \mu$ s, $V_{IN} = 2.8$ V**



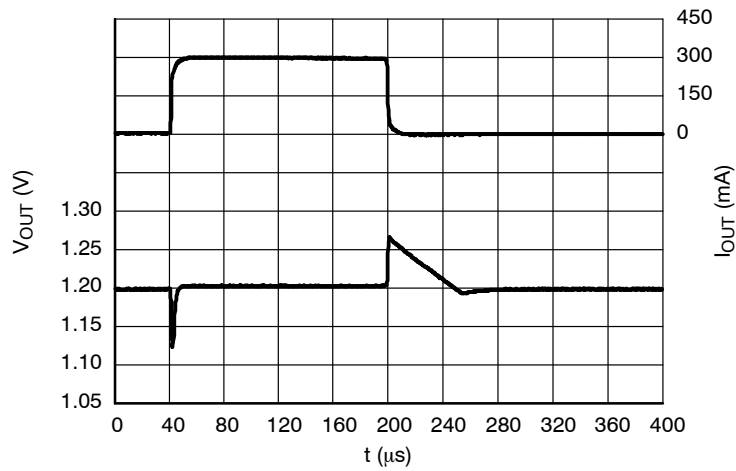
**Figure 45. Load Transients, 2.8 V Version,
 $I_{OUT} = 50 - 100$ mA, $t_R = t_F = 0.5 \mu$ s, $V_{IN} = 3.8$ V**

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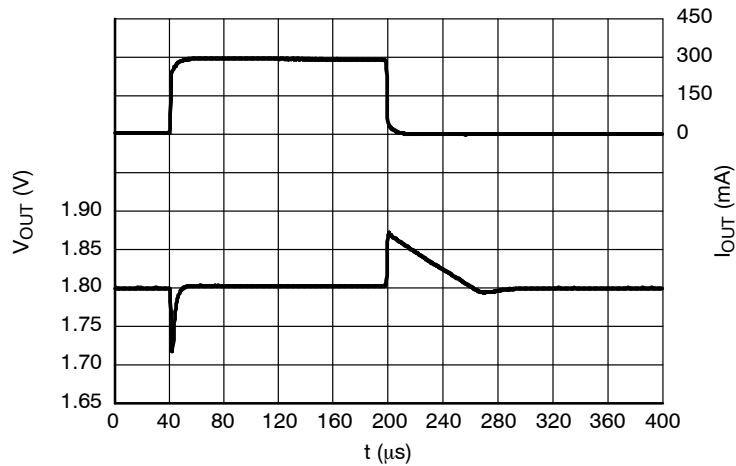
TYPICAL CHARACTERISTICS



**Figure 46. Load Transients, 3.3 V Version,
 $I_{OUT} = 50 - 100 \text{ mA}$, $t_R = t_F = 0.5 \mu s$, $V_{IN} = 4.3 \text{ V}$**



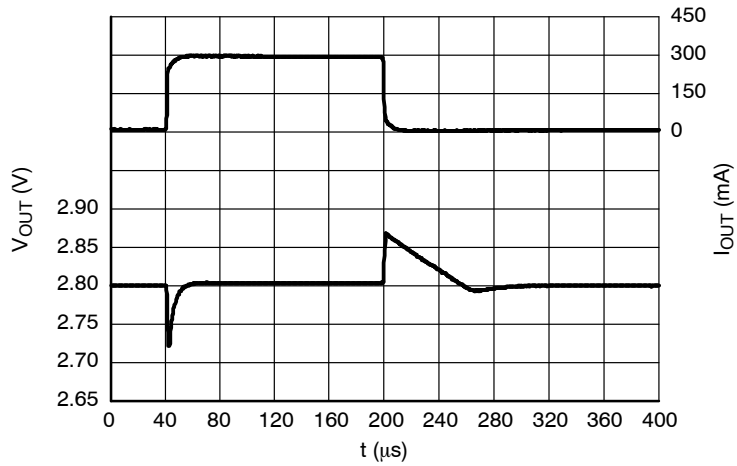
**Figure 47. Load Transients, 1.2 V Version,
 $I_{OUT} = 1 - 300 \text{ mA}$, $t_R = t_F = 0.5 \mu s$, $V_{IN} = 2.2 \text{ V}$**



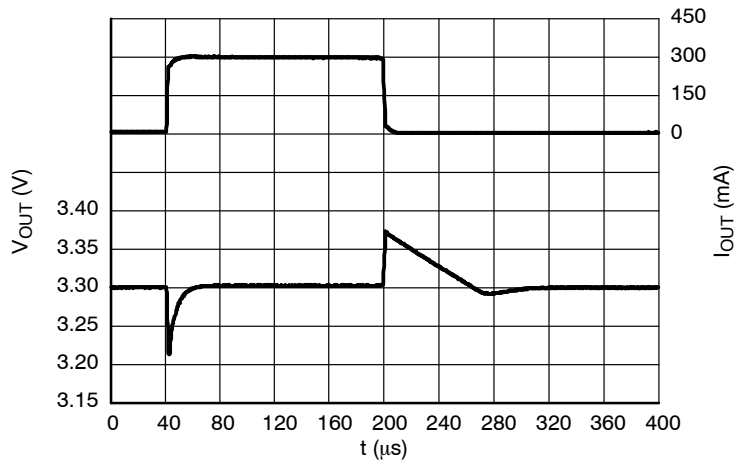
**Figure 48. Load Transients, 1.8 V Version,
 $I_{OUT} = 1 - 300 \text{ mA}$, $t_R = t_F = 0.5 \mu s$, $V_{IN} = 2.8 \text{ V}$**

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TYPICAL CHARACTERISTICS



**Figure 49. Load Transients, 2.8 V Version,
 $I_{OUT} = 1 - 300 \text{ mA}$, $t_R = t_F = 0.5 \mu\text{s}$, $V_{IN} = 3.8 \text{ V}$**



**Figure 50. Load Transients, 3.3 V Version,
 $I_{OUT} = 1 - 300 \text{ mA}$, $t_R = t_F = 0.5 \mu\text{s}$, $V_{IN} = 4.3 \text{ V}$**

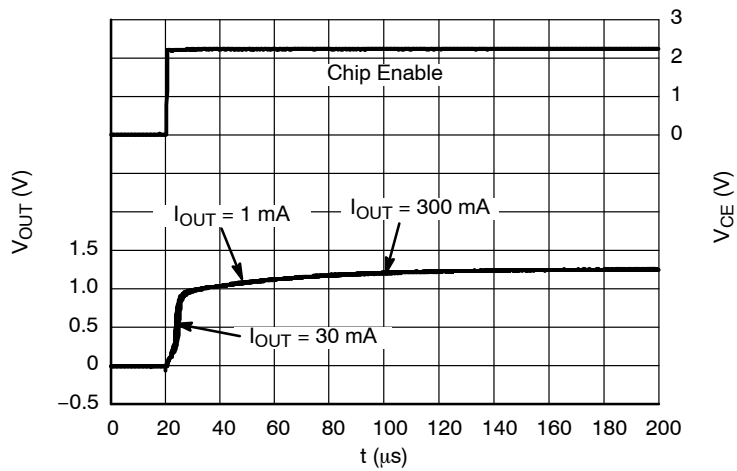


Figure 51. Start-up, 1.2 V Version, $V_{IN} = 2.2 \text{ V}$

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TYPICAL CHARACTERISTICS

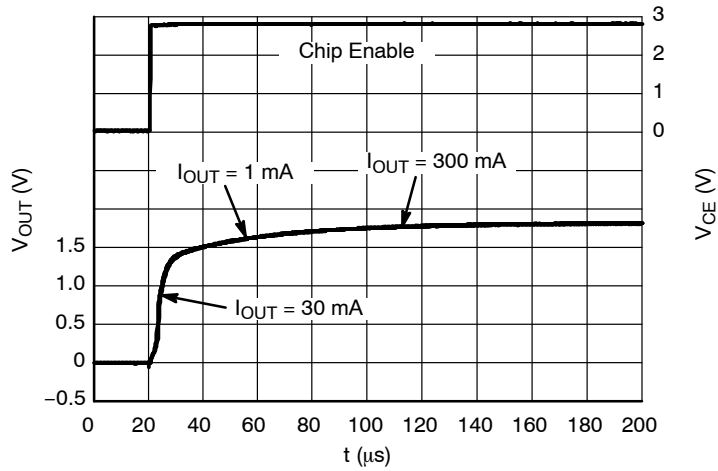


Figure 52. Start-up, 1.8 V Version, $V_{IN} = 2.8 V$

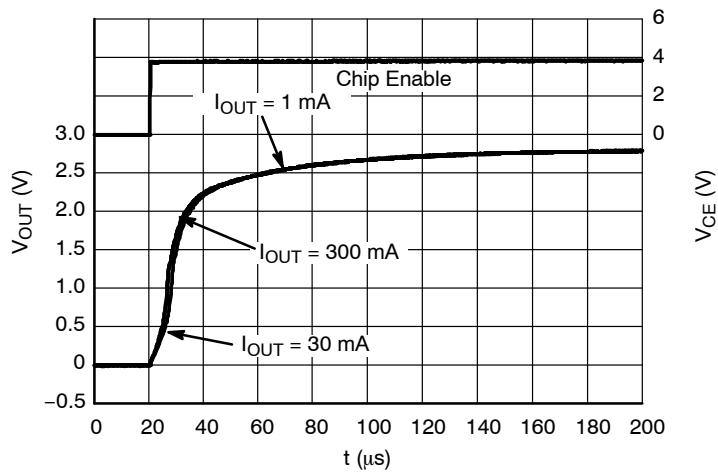


Figure 53. Start-up, 2.8 V Version, $V_{IN} = 3.8 V$

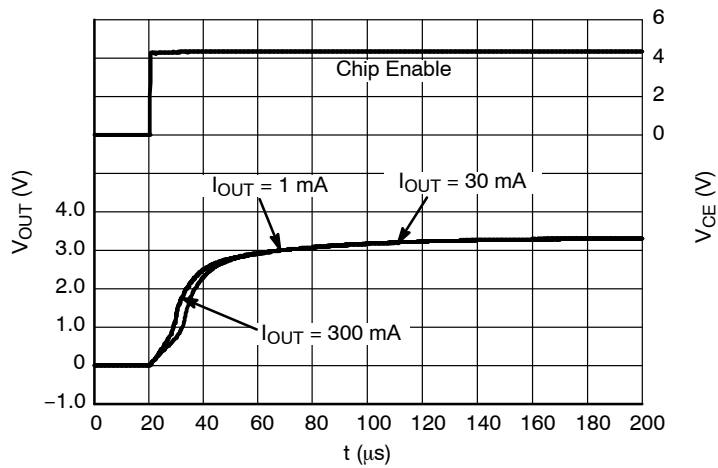


Figure 54. Start-up, 3.3 V Version, $V_{IN} = 4.3 V$

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TYPICAL CHARACTERISTICS

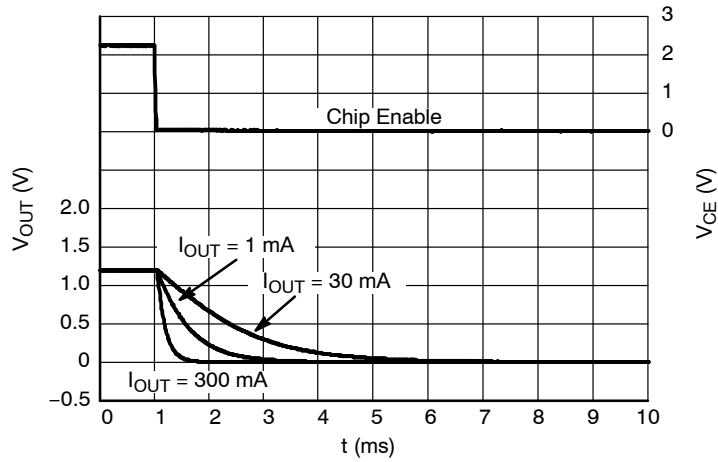


Figure 55. Shutdown, 1.2 V Version B,
 $V_{IN} = 2.2$ V

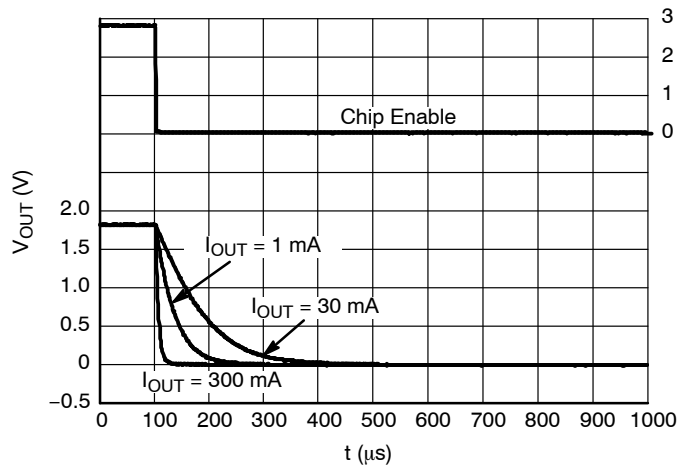


Figure 56. Shutdown, 1.8 V Version D,
 $V_{IN} = 2.8$ V

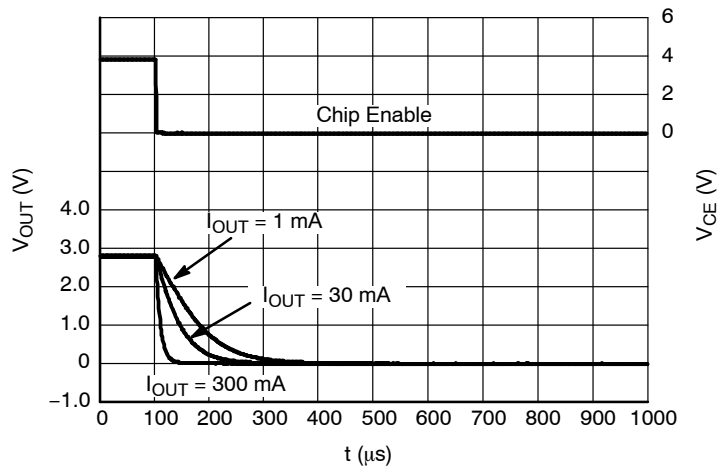


Figure 57. Shutdown, 2.8 V Version D,
 $V_{IN} = 3.8$ V

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TYPICAL CHARACTERISTICS

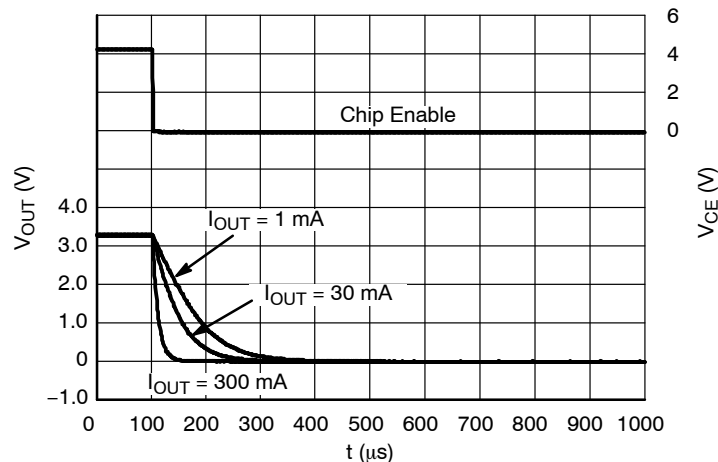


Figure 58. Shutdown, 3.3 V Version D,
 $V_{IN} = 4.3 \text{ V}$

APPLICATION INFORMATION

A typical application circuit for NCP4683 series is shown in Figure 59.

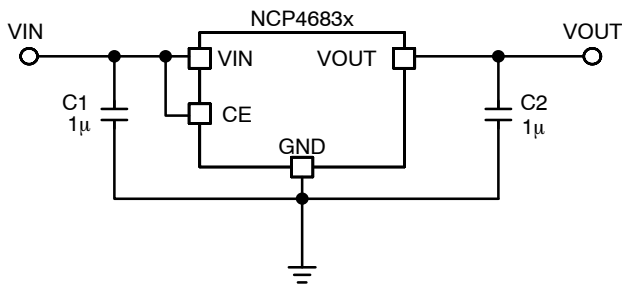


Figure 59. Typical Application Schematic

Input Decoupling Capacitor (C1)

A 1 μF ceramic input decoupling capacitor should be connected as close as possible to the input and ground pin of the NCP4683. Higher values and lower ESR improves line transient response.

Output Decoupling Capacitor (C2)

A 1 μF ceramic output decoupling capacitor is enough to achieve stable operation of the IC. If a tantalum capacitor is used, and its ESR is high, loop oscillation may result. The capacitors should be connected as close as possible to the output and ground pins. Larger values and lower ESR improves dynamic parameters.

Enable Operation

The enable pin CE may be used for turning the regulator on and off. The IC is switched on when a high level voltage is applied to the CE pin. The enable pin has an internal pull

down current source. If the enable function is not needed connect CE pin to VIN.

Current Limit

This regulator includes fold-back type current limit circuit. This type of protection doesn't limit current up to current capability in normal operation, but when over current occurs, output voltage and current decrease until over current condition ends. Typical characteristics of this protection type can be observed in the Output Voltage vs. Output Current graphs shown in the typical characteristics chapter of this datasheet.

Output Discharger

The D version includes a transistor between VOUT and GND that is used for faster discharging of the output capacitor. This function is activated when the IC goes into disable mode.

Thermal

As power across the IC increase, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and also the ambient temperature affect the rate of temperature increase for the part. When the device has good thermal conductivity through the PCB the junction temperature will be relatively low in high power dissipation applications.

PCB layout

Make the VIN and GND line as large as practical. If their impedance is high, noise pickup or unstable operation may result. Connect capacitors C1 and C2 as close as possible to the IC, and make wiring as short as possible.

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ORDERING INFORMATION

Device	Nominal Output Voltage	Description	Marking	Package	Shipping [†]
NCP4683DMU12TCG	1.20	Auto discharge	Q4	UDFN4 (Pb-Free)	10000 / Tape & Reel
NCP4683DMU185TCG	1.85	Auto discharge	T0	UDFN4 (Pb-Free)	10000 / Tape & Reel
NCP4683DMU285TCG	2.85	Auto discharge	T1	UDFN4 (Pb-Free)	10000 / Tape & Reel
NCP4683HMU12TCG	1.20	Standard	L4	UDFN4 (Pb-Free)	10000 / Tape & Reel
NCP4683HMU185TCG	1.85	Standard	P0	UDFN4 (Pb-Free)	10000 / Tape & Reel
NCP4683DSQ18T1G	1.80	Auto discharge	AH18	SC-70 (Pb-Free)	3000 / Tape & Reel
NCP4683DSQ28T1G	2.80	Auto discharge	AH28	SC-70 (Pb-Free)	3000 / Tape & Reel
NCP4683DSQ33T1G	3.30	Auto discharge	AH33	SC-70 (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

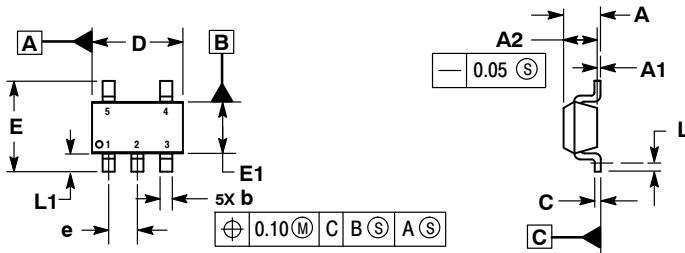
*Marking codes for XDFN0808 packages are unified.

**To order other package and voltage variants, please contact your ON Semiconductor sales representative.

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PACKAGE DIMENSIONS

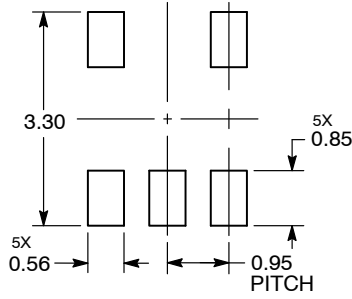
SOT-23 5-LEAD
CASE 1212-01
ISSUE A



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSIONS: MILLIMETERS.
 3. DATUM C IS THE SEATING PLANE.

MILLIMETERS		
DIM	MIN	MAX
A	---	1.45
A1	0.00	0.10
A2	1.00	1.30
b	0.30	0.50
c	0.10	0.25
D	2.70	3.10
E	2.50	3.10
E1	1.50	1.80
e	0.95 BSC	
L	0.20	---
L1	0.45	0.75

RECOMMENDED SOLDERING FOOTPRINT*



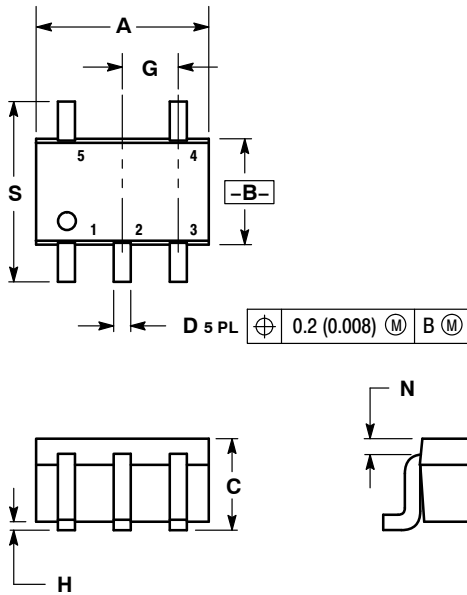
DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NCP4683

PACKAGE DIMENSIONS

SC-88A (SC-70-5/SOT-353)
CASE 419A-02
ISSUE K



NOTES:

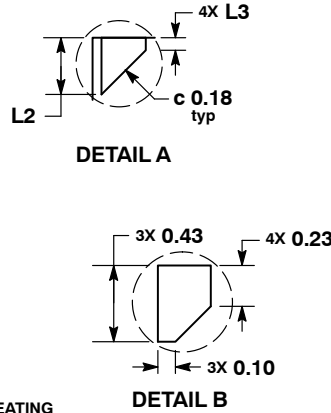
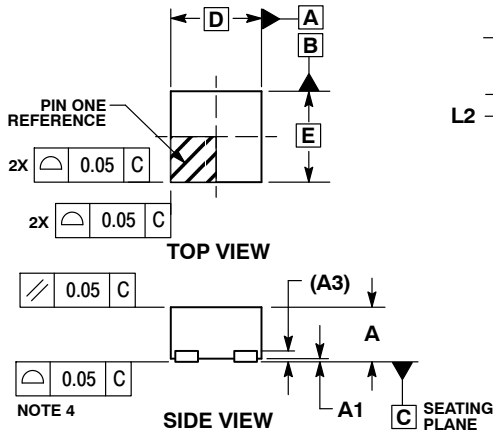
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419A-01 OBSOLETE. NEW STANDARD 419A-02.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.071	0.087	1.80	2.20
B	0.045	0.053	1.15	1.35
C	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026 BSC		0.65 BSC	
H	---	0.004	---	0.10
J	0.004	0.010	0.10	0.25
K	0.004	0.012	0.10	0.30
N	0.008 REF		0.20 REF	
S	0.079	0.087	2.00	2.20

NCP4683

PACKAGE DIMENSIONS

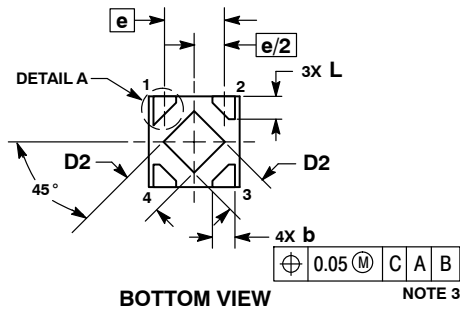
UDFN4 1.0x1.0, 0.65P CASE 517BR-01 ISSUE O



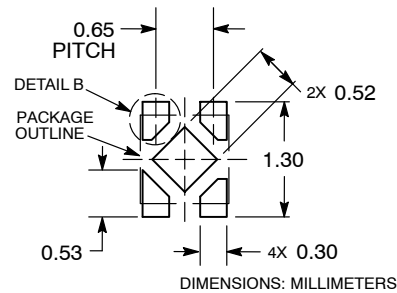
NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 mm FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIM	MILLIMETERS	
	MIN	MAX
A	---	0.60
A1	0.00	0.05
A3	0.10	REF
b	0.20	0.30
D	1.00	BSC
D2	0.43	0.53
E	1.00	BSC
e	0.65	BSC
L	0.20	0.30
L2	0.27	0.37
L3	0.02	0.12



RECOMMENDED MOUNTING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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